



Product Change Notification

111685 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 111685 - 00
Change Title: Intel® Server Chassis P4304XXSFDR
PCN 111685-00, Product Design
Update Power Supply
Date of Publication: August 14, 2012

Key Characteristics of the Change:

Product Design

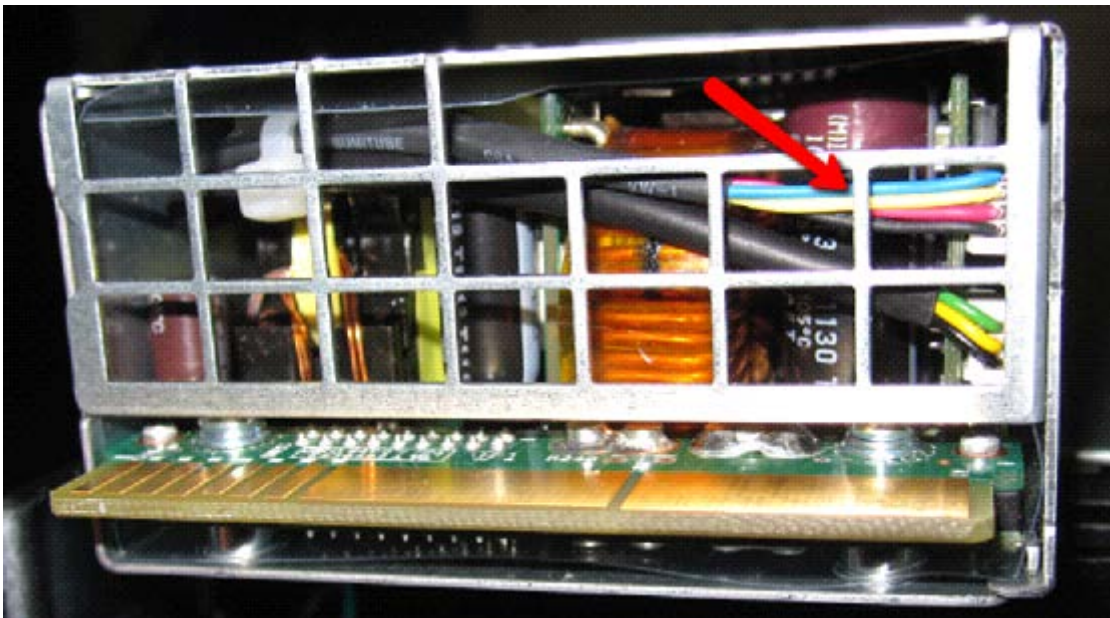
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Aug 29, 2012
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Description of Change to the Customer:

Intel has implemented the following two changes:

1. The firmware of the 460W Common Redundant Power Supply is updated to improve the system power stability during power capping for Node Manager Implementation.
2. The shrink tube around the Power Supply wires inside the forward ends of the Power Supplies is lengthened. This prevents the wires from rubbing against the grill and cutting into the insulation during vibration. See below picture:



Customer Impact of Change and Recommended Action:

Customers may want to perform re-qualification, re-test or standard validation for the updated power supply. However, customers do not need to do a re-certification for the new power supply.

Products Affected / Intel Ordering Codes:

EMEA LSIC SKU			
Product Code	MM#	Pre Change TA	Post Change TA
P4304XXSFDR	916302	G51305-001	G51305-002

PCN Revision History:

Date of Revision:
August 14, 2012

Revision Number:
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Reason:
Originally Published PCN